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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
09/633,782	08/07/2000	Gun-Hee Lee	3430-0129P	3862	
7590 01/13/2005			EXAMINER		
BIRCH, STEWART, KOLASCH & BIRCH, LLP			NGUYEN,	NGUYEN, HOAN C	
P. O. Box 747 Falls Church. V	/A 22040-0747		ART UNIT	ART UNIT PAPER NUMBER	
,			2871		
			DATE MAILED: 01/13/200	5	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
Advisory Action	09/633,782	LEE ET AL.					
Autisory Aution	Examiner	Art Unit					
	HOAN C. NGUYEN	2871					
The MAILING DATE of this communication appe	ars on the cover sheet with the c	orrespondence add	ress				
THE REPLY FILED 23 December 2004 FAILS TO PLACE Therefore, further action by the applicant is required to average final rejection under 37 CFR 1.113 may only be either: (1) condition for allowance; (2) a timely filed Notice of Appea Examination (RCE) in compliance with 37 CFR 1.114.	oid abandonment of this application a timely filed amendment which	ation. A proper repl h places the applica	y to a ition in				
PERIOD FOR RE	EPLY [check either a) or b)]						
 a)	Advisory Action, or (2) the date set forth ater than SIX MONTHS from the mailin	g date of the final rejecti	on.				
Extensions of time may be obtained under 37 CFR 1.136(a). The fee have been filed is the date for purposes of determining the period of fee under 37 CFR 1.17(a) is calculated from: (1) the expiration date of (2) as set forth in (b) above, if checked. Any reply received by the Official timely filed, may reduce any earned patent term adjustment. See 37 C	of extension and the corresponding amoust the shortened statutory period for reply be later than three months after the mai	ount of the fee. The apportion or the final originally set in the final	ropriate extension Office action; or				
1. A Notice of Appeal was filed on Appellant's Brief must be filed within the period set forth in 37 CFR 1.192(a), or any extension thereof (37 CFR 1.191(d)), to avoid dismissal of the appeal.							
$2. \boxtimes$ The proposed amendment(s) will not be entered be	ecause:						
(a) ⊠ they raise new issues that would require further consideration and/or search (see NOTE below);							
(b) ☐ they raise the issue of new matter (see Note below);							
(c) they are not deemed to place the application in issues for appeal; and/or	n better form for appeal by mate	rially reducing or si	mplifying the				
(d) they present additional claims without cancel	ng a corresponding number of f	inally rejected claim	ıs. · .				
NOTE: See Continuation Sheet.							
3. Applicant's reply has overcome the following reject	tion(s):		•				
4. Newly proposed or amended claim(s) would canceling the non-allowable claim(s).	be allowable if submitted in a se	eparate, timely filed	amendment				
5. The a) affidavit, b) exhibit, or c) request for application in condition for allowance because:		idered but does NO	T place the				
6. The affidavit or exhibit will NOT be considered becariesed by the Examiner in the final rejection.	ause it is not directed SOLELY	to issues which wer	e newly				
7. For purposes of Appeal, the proposed amendment explanation of how the new or amended claims we			and an				
The status of the claim(s) is (or will be) as follows:							
Claim(s) allowed:							
Claim(s) objected to:			•				
Claim(s) rejected: <u>1-20</u> .							
Claim(s) withdrawn from consideration:	,		·				
-8. The drawing correction-filed on is a) app	roved or b) disapproved by	the-Examiner.					
9. Note the attached Information Disclosure Statement(s)(PTO-1449) Paper No(s).							
10. Other:	Supe	RCISCI H. KIM HVISCIN PATENT EX CIMOLOGY CENTER	2003 2003				

Continuation of 2. NOTE: The amended claims 1 and 12 raise the following New Issues: "an ohmic layer on the active layer" and "a source and a drain electrodes on the ohmic layer".